

Features

- 5.5mmx5.0mm RGBW LED
- Full color LED
- Built-in Red / Green / Blue and White quad chip
- High efficiency / high light output
- Pb free and ROHS Compliant product
- SMT compatible package

Applications

- Indication
- Information boards
- Amusement equipment
- Full color application
- General use

Description

The IN-P55QDTRGBW is PLCC8 RGBW LED. It is a SMD type LED which can be used in various applications.

Recommended Solder Pattern

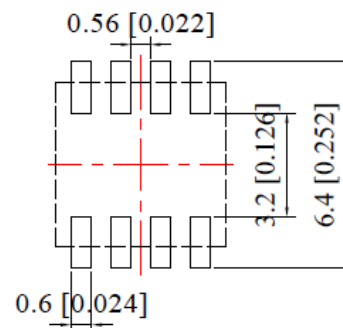
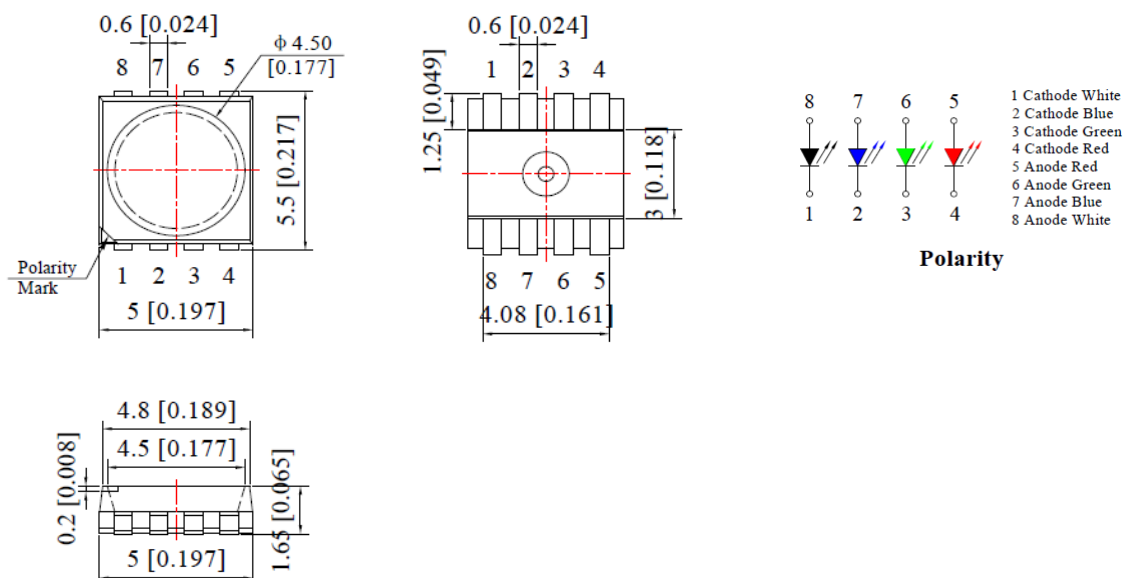


Figure 1. IN-P55QDTRGBW Solder Pattern

Package Dimensions in mm



Notes.

1. All dimensions are in millimeters.
2. Tolerance is ± 0.25 mm unless otherwise noted

Figure 2. IN-P55QDTRGBW Package Dimensions

Absolute Maximum Rating at Ta=25°C

Parameter	Symbol	Max.				Unit
		Red	Green	Blue	White	
Average Forward Current	I _F	30				mA
Peak Forward Current	I _{peak}	100				mA
Reverse Voltage	V _R	Not designed for reverse operation				-
Power Dissipation	P _D	52	72	72	108	mW
Operating Temperature Range	T _{OPR}	-40 ~ 80				°C
Storage Temperature Range	T _{STO}	-40 ~ 85				°C
Lead Soldering Condition (Reflow)	T _{SOL}	Below 260°C , Max. 5 seconds				

Notes

1. D=0.01s duty 1/10.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics at Ta=25°C

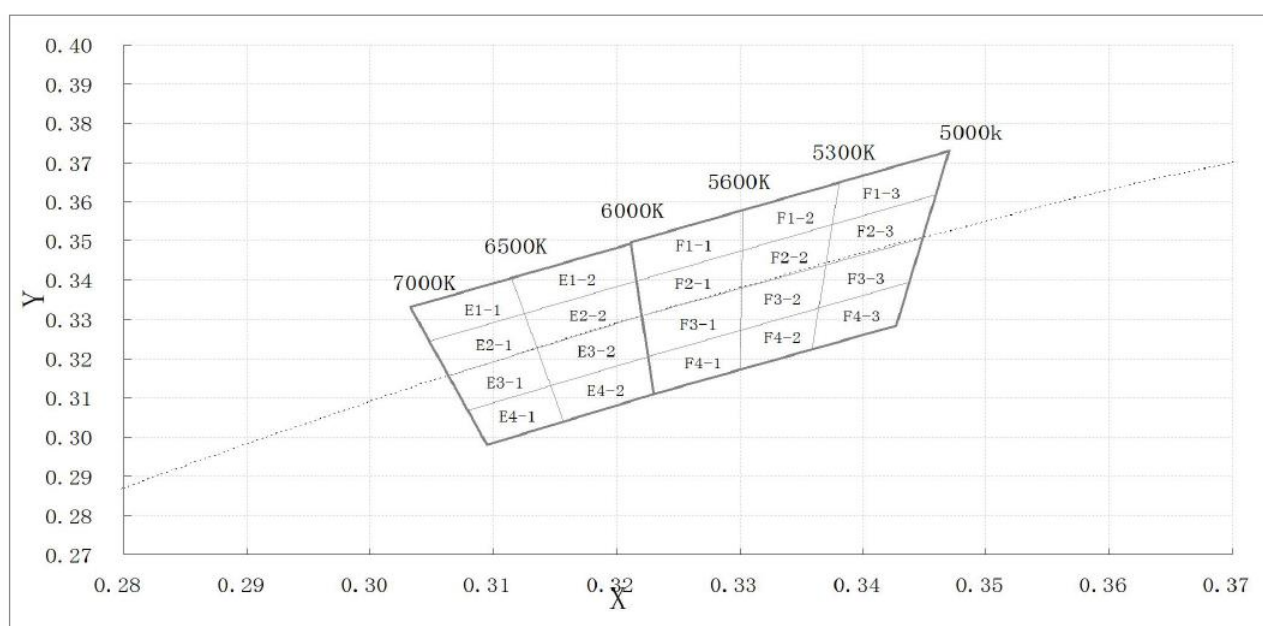
Product	Emission Color	I _F (mA)	V _F (V)		λ _d (nm)	Viewing Angle (°)	Luminous Intensity I _v (mcd)	Luminous Flux I _v (lm)
			typ.	max				
IN-P55QDTRGBW	Red	20	2.0	2.6	624	120	500	-
	Green	20	3.2	3.6	525	120	2200	-
	Blue	20	3.2	3.6	470	120	450	-
	White	30	3.2	3.6	CCT=6500K	120	-	10

Notes

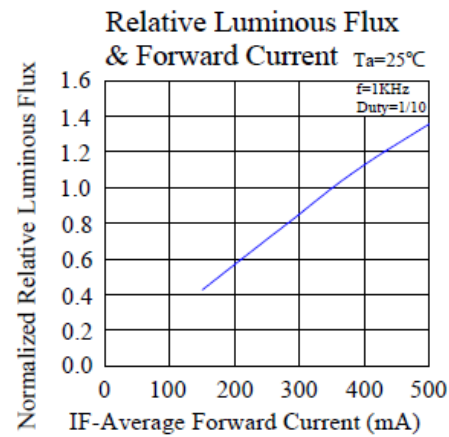
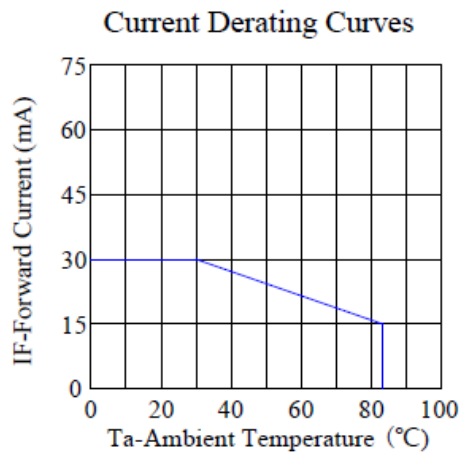
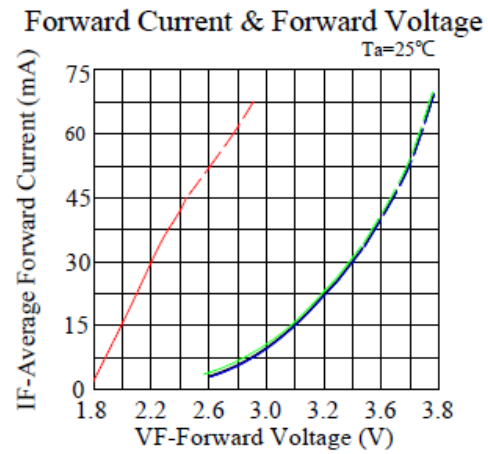
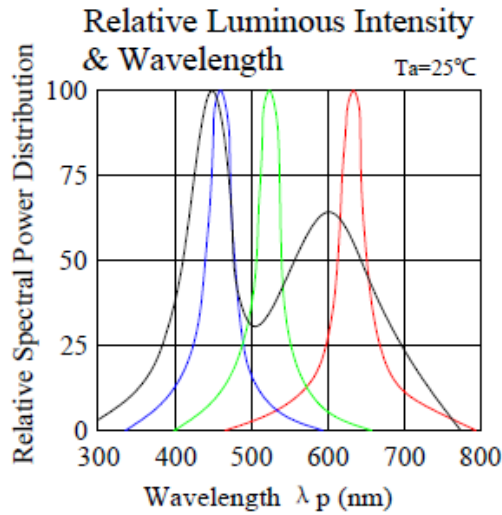
1. Performance guaranteed only under conditions listed in above tables.
2. Viewing angle(2θ_{1/2}) ±10°

Chromaticity Bin (for White only)

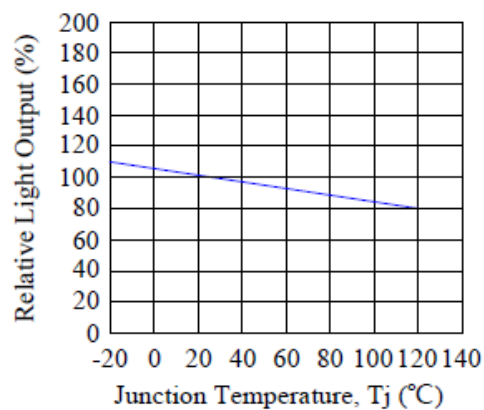
Bin Code	Left x	Left y	Top x	Top y	Right x	Right y	Bottom x	Bottom y
E1-1	0.305	0.324	0.313	0.331	0.312	0.341	0.303	0.333
E2-1	0.306	0.316	0.314	0.323	0.313	0.331	0.305	0.324
E3-1	0.308	0.307	0.315	0.313	0.314	0.323	0.306	0.316
E4-1	0.310	0.298	0.316	0.304	0.315	0.313	0.308	0.307
E1-2	0.313	0.331	0.323	0.340	0.323	0.349	0.312	0.341
E2-2	0.314	0.323	0.323	0.330	0.323	0.340	0.313	0.331
E3-2	0.315	0.313	0.323	0.321	0.323	0.330	0.314	0.323
E4-2	0.316	0.304	0.323	0.311	0.323	0.321	0.315	0.313
F1-1	0.323	0.340	0.330	0.347	0.330	0.357	0.323	0.349
F2-1	0.323	0.330	0.330	0.337	0.330	0.347	0.323	0.340
F3-1	0.323	0.321	0.330	0.327	0.330	0.337	0.323	0.330
F4-1	0.323	0.311	0.330	0.317	0.330	0.327	0.323	0.321
F1-2	0.330	0.347	0.337	0.354	0.338	0.365	0.330	0.357
F2-2	0.330	0.337	0.337	0.343	0.337	0.354	0.330	0.347
F3-2	0.330	0.327	0.337	0.333	0.337	0.343	0.330	0.337
F4-2	0.330	0.317	0.337	0.322	0.337	0.333	0.330	0.327
F1-3	0.337	0.354	0.346	0.362	0.347	0.373	0.338	0.365
F2-3	0.337	0.343	0.345	0.351	0.346	0.362	0.337	0.354
F3-3	0.337	0.333	0.344	0.340	0.345	0.351	0.337	0.343
F4-3	0.337	0.322	0.343	0.328	0.344	0.340	0.337	0.333



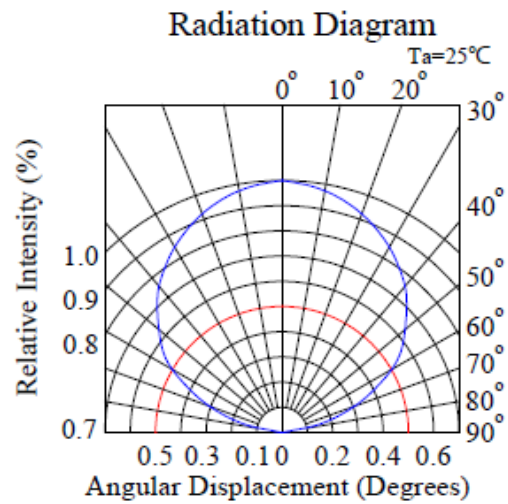
Typical Characteristic Curves



Light Output Characteristics





Typical Characteristic Curves – Radiation Pattern



Ordering Information

Product	Emission Color	Test Current I_F (mA)	Luminous Intensity I_V (mcd) (Typ.)	Luminous Flux I_V (lm) (Typ.)	Forward Voltage V_F (V) (Typ.)	Orderable Part Number
IN-P55QDTRGBW	Red	20	500	-	2.0	IN-P55QDTRGBW
	Green	20	2200	-	3.2	
	Blue	20	450	-	3.2	
	White	30	-	10	3.2	

Label Specifications

		Date: yyyy/mm/dd
CUSTOMER P/N: 		
INOLUX P/N:	QTY:	PCS
LOT NO: 		
IV BIN:	COLOR BIN:	VF:
		QC

Inolux P/N:

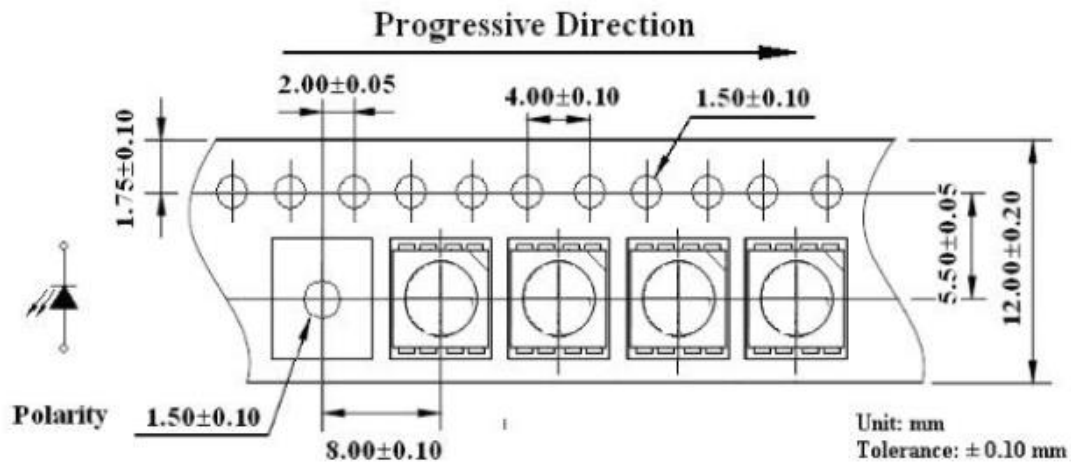
I	N	-	P	5	5	QD	T			R	G	B	W		-	X	X	X	X
Inolux SMD			Material	Package	Variation	Orientation	Current	Lens	Color				Chip Type		Customized Stamp-off				
			PLCC - P	55QD = 5.5x5.0x1.65mm PLCC8 RGBW		T= Top Mount	(Blank) = 20mA	(Blank) = clear	R=630nm G=525nm B=453nm W=White				(blank) = Standard						

Lot No.:

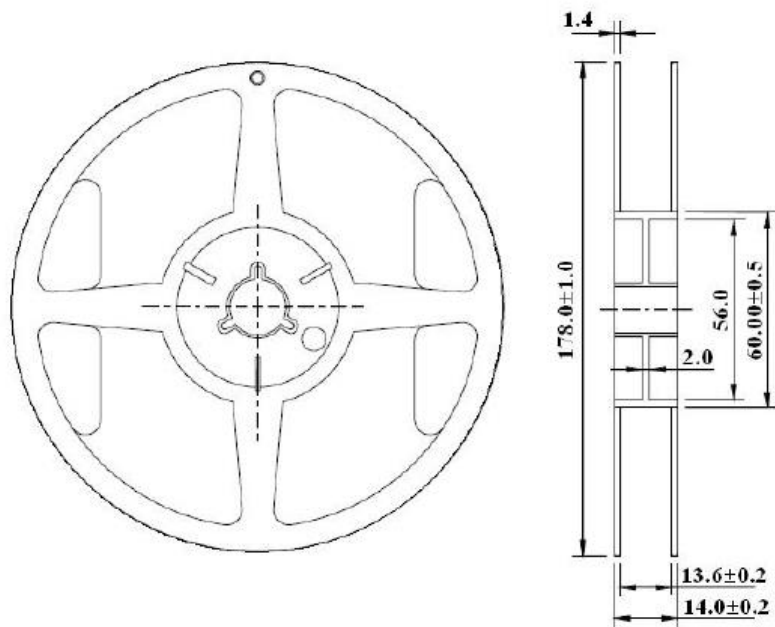
Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018,)				Month	Date	Serial

Packaging Information: 1000pcs Per Reel

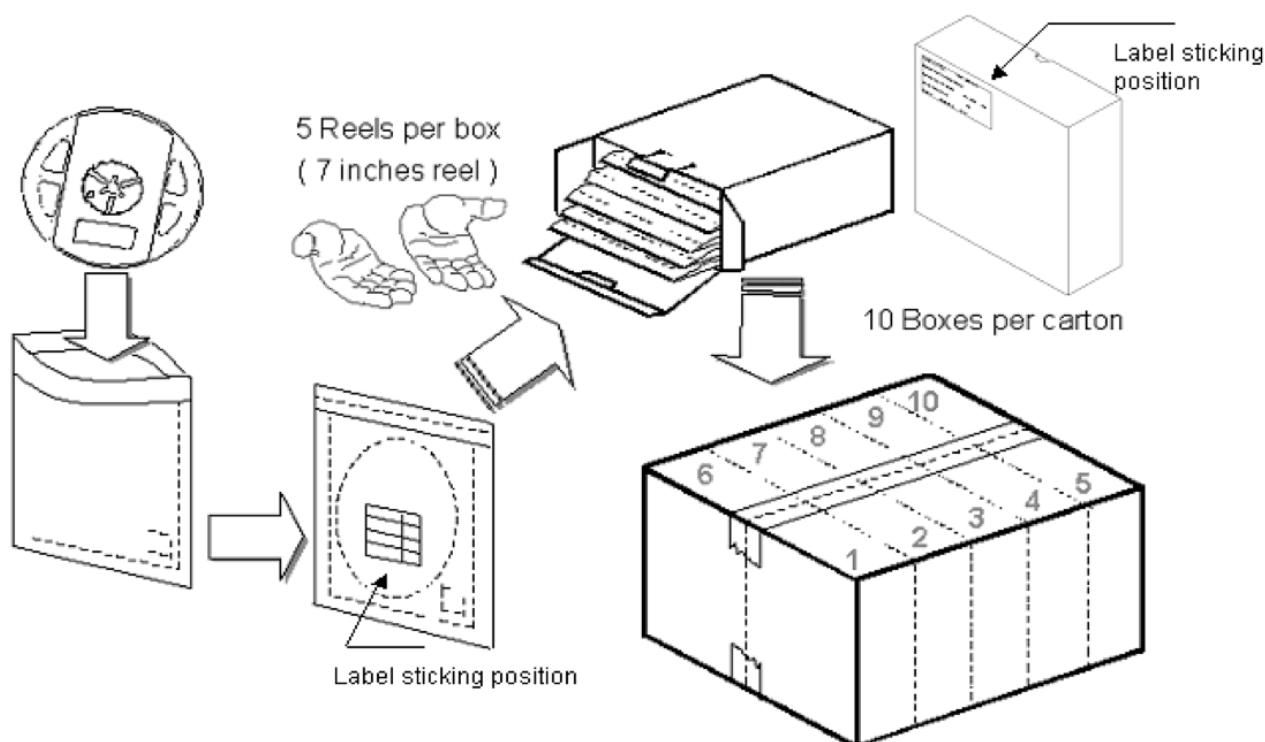
Tape Dimension



Reel Dimensions



Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	1000 pcs
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

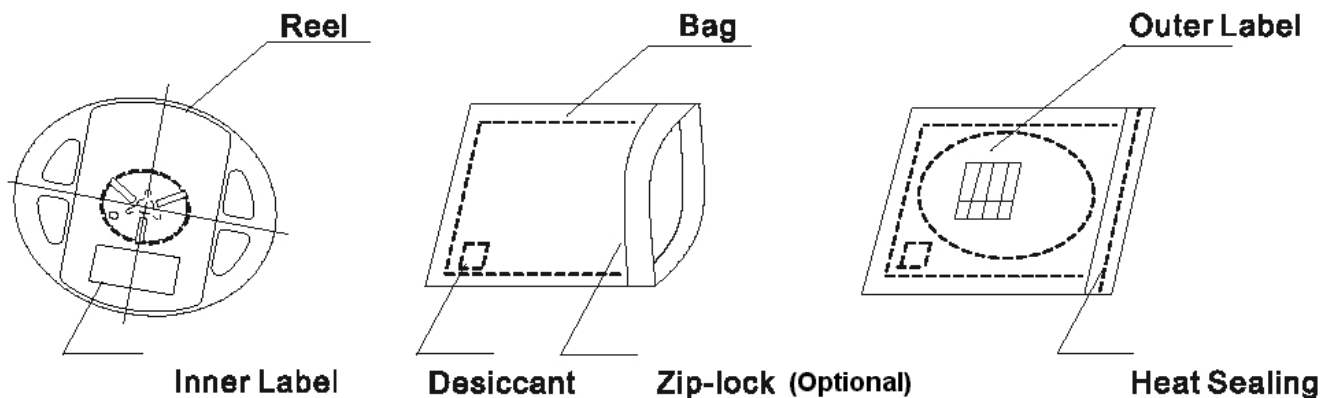
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of I_v , λ_D and V_f . Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

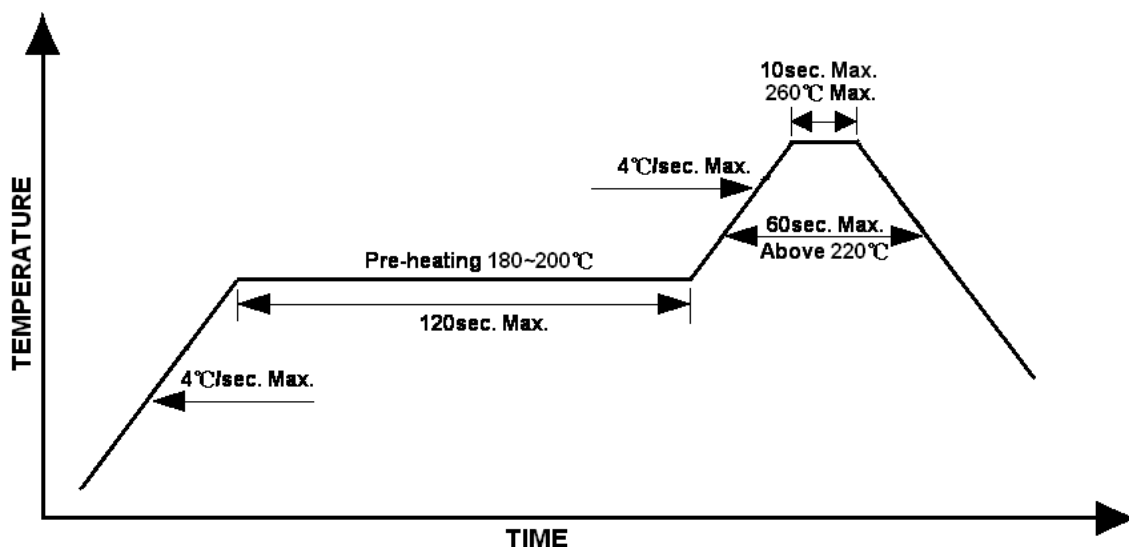
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μ s, T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min.. 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	04-22-2019

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